

# TVU1240R1A Specification

Product Name Series Part No Size ESD Guard<sup>™</sup> Array TVU Series TVU1240R1A EIA 1004





TVU1240R1A Product Engineering Specification

# 1. Scope

This specification is applied to protect sensitive electronic circuits from the threat of electrostatic discharge (ESD). The function meets with the requirement of IEC61000-4-2 specification. The extreme low capacitance is suit for HDMI ESD protection application.

#### Feature

- Protection against ESD voltages and currents (IEC61000-4-2 Level 4)
- Extremely quick response time (<1ns) present ideal ESD protection
- Extremely low capacitance (0.1pF typical)
- Extremely low leakage current
- SMD (Surface Mount Device)
- Zero signal distortion
- Lead Free, RoHS Compliance

#### Applications

TVU1240R1A is applied to high speed signal interface.

- Antenna circuit
- USB2.0
- IEEE-1394
- DVI
- HDMI

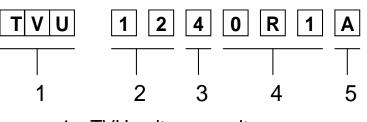
#### **Product Model**

- Digital Video Equipment
- Mobile Phone
- GPS Antenna
- Bluetooth Communication Equipment

TVU1240R1A Engineer Specification	Version: A6	Page 1 of 10
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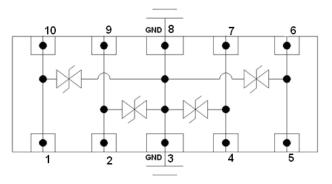


# 2. Explanation of Part Number

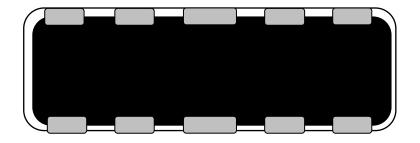


- 1 : TVU : ultra capacitance
- ◆ 2 : Working voltage:VDC 12V
- ◆ 3 : Channel : 4 channels
- ◆ 4 : Capacitance: 0.1pF
- 5 : Chip size:L:2.5mm W:1.0mm

# 3. Circuit symbol



Pin	Identification
1,2,4,5,	Data Lines
6,7,9,10	Data Lines (No Internal Connection)
3,8 (GND)	Ground

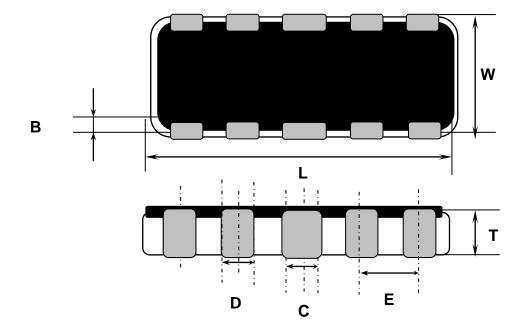


TVU1240R1A Engineer Specification	Version: A6	Page 2 of 10
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# 4. Construction & Dimensions

- 4.1. End termination: Ag/Ni/Sn
- 4.2. Construction & Dimension :



Unit: mm

L	W	Т	В	С	D	E
2.5±0.1	1.0±0.1	0.5±0.1	0.2±0.1	0.3±0.05	0.2±0.05	0.5±0.05

TVU1240R1A Engineer Specification	Version: A6	Page 3 of 10
All Specifications are subject to change without notice.	<u>www.inpaq.com.tw</u> ;	www.inpaqgp.com



# 5. General specifications

5.1. Temperature Specifications

Operating Temperature range	: <b>-55°</b> ℃ to <b>+125</b> ℃
Storage Temperature range	: -55℃ to +125℃

# 6. Performance Characteristics

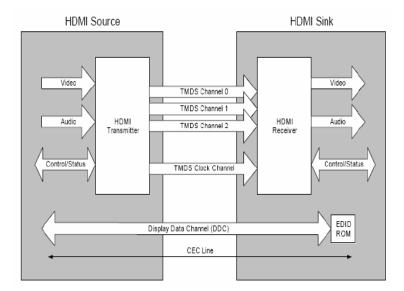
Characteristic	Value
Rated voltage (max)	12V
Leakage current (max) (@12VDC)	0.01µA
Trigger voltage(Vt)	300V typical
Clamping voltage (Vc)	30V typical
Capacitance (Cp), @1MHz	0.1pF typical
Response time	<1ns
ESD voltage capability, IEC 61000-4-2 Contact discharge mode	10KV
ESD voltage capability, IEC 61000-4-2 Air discharge mode	15KV
ESD withstand pulses	1000 typical

 $\mbox{Cp}-\mbox{Device}$  capacitance measured with  $1\mbox{Vrms}$ 

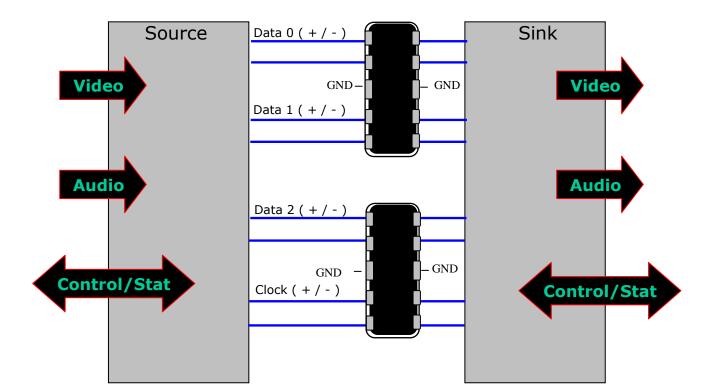
TVU1240R1A Engineer Specification	Version: A6	Page 4 of 10
All Specifications are subject to change without notice.	www.inpaq.com.tw ; www.inpaqgp.com	



# 7. HDMI Interface Application



## HDMI block Diagram



TVU1240R1A Engineer Specification	Version: A6	Page 5 of 10
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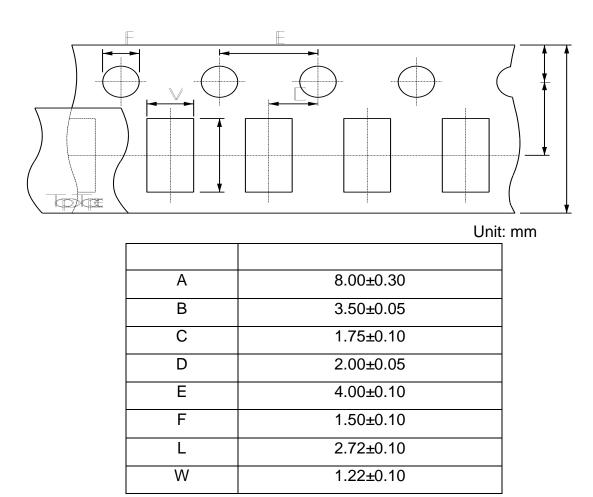


# 8. Taping Package and Label Marking

### 8.1. Packaging method

- 8.1.1. Products shall be heat-sealed in the chip pocket, spacing pitch 2-mm of paper carrier tape with cover tape, and the carrier tape shall be reeled to the reel.
- 8.1.2. Tape material to be paper. Tape thickness to be  $0.75\pm0.05$  mm.
- 8.1.3. Cover tape adhesion to be 35  $\pm$  25 grams.

#### 8.2. Carrier tape dimensions

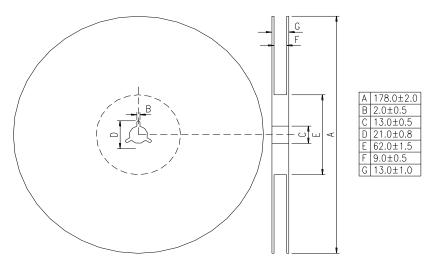


TVU1240R1A Engineer Specification	Version: A6	Page 6 of 10
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#### 8.3. Taping reel dimensions

#### Unit: mm



8.4. Taping specifications

There shall be the portion having no product in both the head and the end of taping, and there shall be the cover tape in the head of taping.

8.5. Label Marking

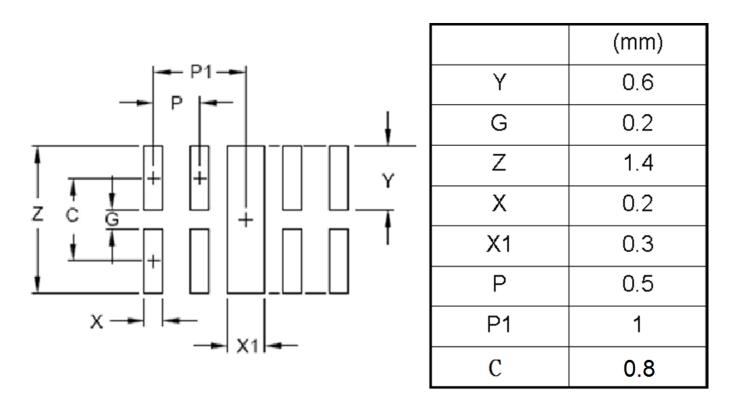
The label specified as follows shall be put on the side of reel.

- (1) Part No.
- (2) Quantity
- (3) Lot No.
- \* Part No. And Quantity shall be marked on outer packaging.
- 8.6. Quantity of products in the taping package
  - (1) Standard quantity : 5000pcs/Reel
  - (2) Shipping quantity is a multiple of standard quantity.

TVU1240R1A Engineer Specification	Version: A6	Page 7 of 10
All Specifications are subject to change without notice.	www.inpaq.com.tw	; www.inpaqgp.com



- 9. Precautions for Handling
  - 9.1. Solder cream in reflow soldering Refer to the recommendable land pattern as printing mask pattern for solder cream.
    - (1) Print solder in a thickness of 0.1 to 0.15 mm.



# 9.2. Precaution for handling of substrateDo not exceed to bend the board after soldering this product extremely.(reference examples)

- Mounting place must be as far as possible from the position, which is close to the break line of board, or on the line of large holes of board.
- Do not bend extremely the board, in mounting another components. If necessary, use back-up pin (support pin) to prevent from bending extremely.
- Do not break the board by hand. We recommend to use the machine or the jig to break it.

TVU1240R1A Engineer Specification	Version: A6	Page 8 of 10
■ All Specifications are subject to change without notice.	www.inpaq.com.tw ; www.inpaqgp.com	

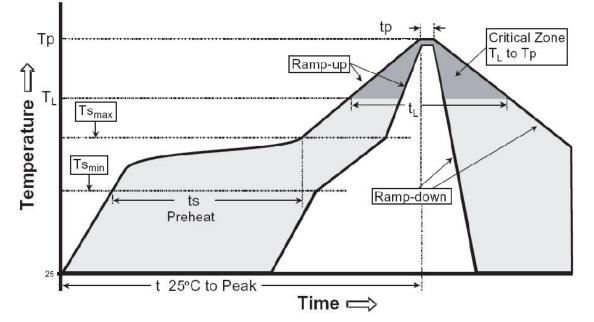


### 9.3. Precaution for soldering

Note that this product will be easily damaged by rapid heating, rapid cooling or local heating.

Do not give heat shock over 100°C in the process of soldering. We recommend to take preheating and gradual cooling.

9.4. Recommendable reflow soldering



Reference IPC-020c-5-1

Profile Feature	Pb free Assembly
Average Ramp Rate	3 °C/second max
(Ts max to Tp)	
Preheat	
- Temperature Min (Ts <sub>min</sub> )	150℃
- Temperature Min (Ts <sub>max</sub> )	200°C
- Time(ts <sub>min</sub> to ts <sub>min</sub> )	60-180 seconds
Time maintained above:	
- Temperature (TL)	<b>217</b> °C
- Time (tL)	60-150 seconds
Peak Temperature (T <sub>p</sub> )	260°C +0/-5 °C
Time within 5 $^\circ C$ of actual Peak	20-40 seconds
Temperature (T <sub>p</sub> )	
Ramp-Down Rate	6 $^{\circ}C$ /second max.
Time 25°C to Peak Temperature	8 minutes max

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9.5. Soldering gun procedure

Note the follows, in case of using solder gun for replacement.

- (1) The tip temperature must be less than 280°C for the period within 3 seconds by using soldering gun under 30 W.
- (2) The soldering gun tip shall not touch this product directly.
- 9.6. Soldering volume

Note that excess of soldering volume will easily get crack the body of this product.

9.7. Taping Package Storage Condition Storage Temperature : 5 to 40 ℃ Relative Humidity: < 65%RH Storage Time : 12 months max

TVU1240R1A Engineer Specification	Version: A6	Page 10 of 10
All Specifications are subject to change without notice.	www.inpaq.com.tw ; www.inpaqgp.com	